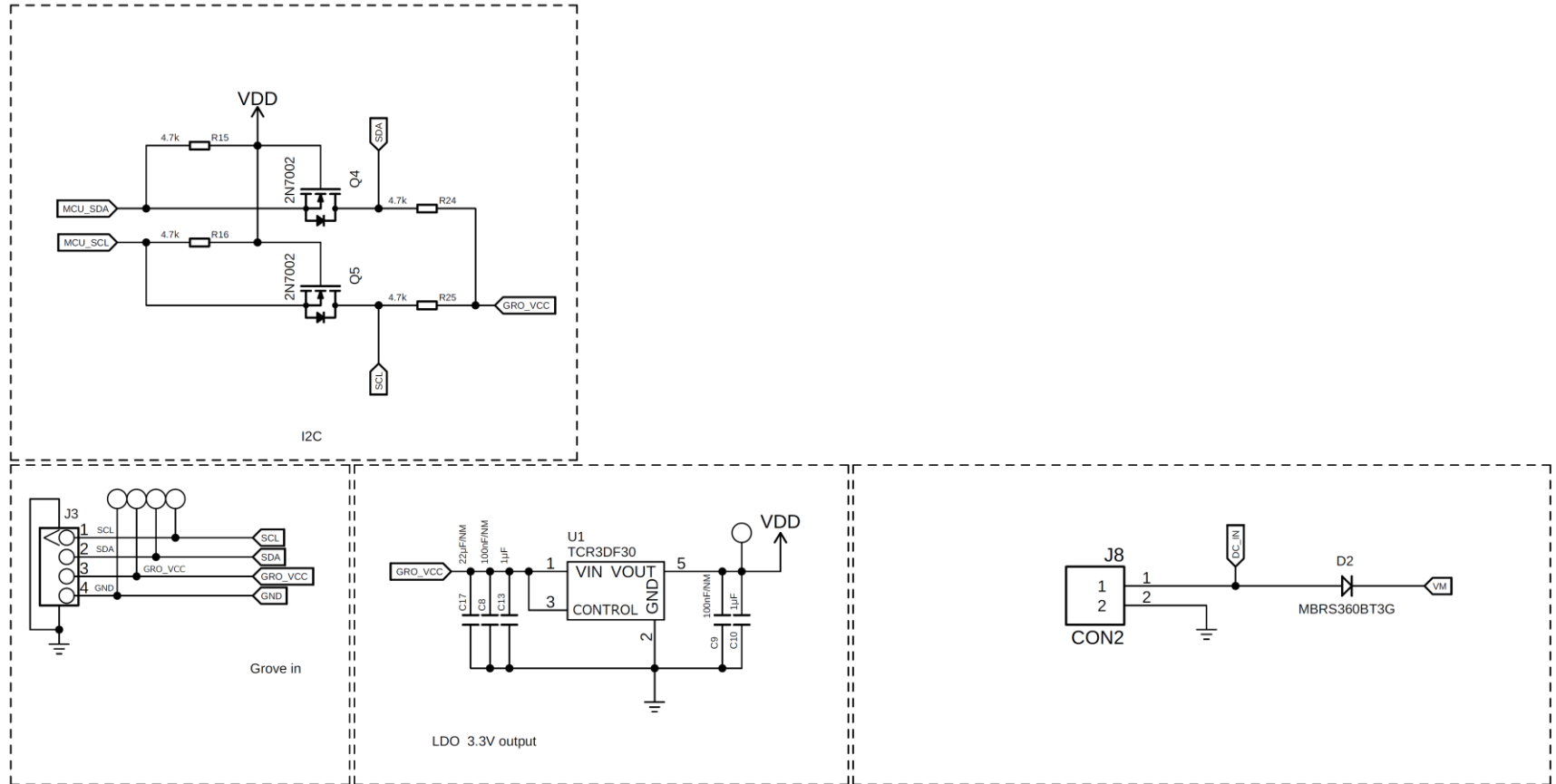


Control Num.	Title	Function	Sheet Num.	Rev.	Date
RD197-SCHEMATIC-01	TB67S128FTG Circuit diagram	Motor Driver	1/2	01	2020-06-02



Control Num.	Title	Function	Sheet Num.	Rev.	Date
RD197-SCHEMATIC-01	TB67S128FTG Circuit diagram	Motor Driver	2/2	01	2020-06-02

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